

### ■ PRODUCT CHARACTERISTICS

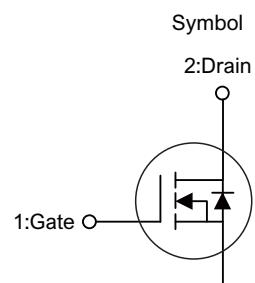
V <sub>DSS</sub>	20V
R <sub>DS(ON)Typ(@V<sub>GS</sub>=2.5V)</sub>	4mΩ
R <sub>DS(ON)Typ(@V<sub>GS</sub>=4.5V)</sub>	2.8mΩ
ID	100A

### ■ APPLICATIONS

Power management in telecom., industrial automation, CE  
 Current switching in DC/DC-AC/DC sub-systems  
 Motor driving in power tool  
 E-vehicle, robotics

### ■ FEATURES

- \*Low gate charge
- \*UIS tested, 100% R<sub>g</sub> tested
- \*Pb-free lead plating
- \*Halogen-free and RoHS-compliant



TO-252

TO-251

### ■ ORDER INFORMATION

Order codes		Package	Packing
Halogen-Free	Halogen		
N/A	MOT100N02D	TO-252	2500 pieces/Reel
N/A	MOT100N02C	TO-251	70 pieces/Tube

### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>c</sub> = 25°C, unless otherwise specified)

Parameter		Symbol	Ratings	Unit
Drain-to-source voltage		V <sub>DSS</sub>	20	V
Gate-to-source voltage		V <sub>GSS</sub>	±12	V
Continuous drain	T <sub>c</sub> =25°C	I <sub>D</sub>	100	A
	T <sub>c</sub> =100°C	I <sub>D</sub>	70	A
Pulsed drain current		I <sub>DM</sub>	360	A
Avalanche energy		E <sub>AS</sub>	118	mJ
Power dissipation		P <sub>D</sub>	88	W
Junction & storage temperature range		T <sub>J,T<sub>STG</sub></sub>	~55 to +150	°C

### ■ THERMAL PERFORMANCE

Parameter		Symbol	Ratings	Unit
Thermal resistance, Junction-to-case		R <sub>θJC</sub>	1.8	°C/W

**■ ELECTRICAL CHARACTERISTICS( $T_c = 25^\circ\text{C}$ , unless otherwise specified)**

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
<b>STATIC PARAMETERS</b>						
Drain-source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	$V_{\text{GS}}=0\text{V}, I_D=250\mu\text{A}$	20	-	-	V
Zero gate voltage drain current	$I_{\text{DSS}}$	$V_{\text{DS}}=20\text{V}, V_{\text{GS}}=0\text{V}$ $T_J = 55^\circ\text{C}$	-	-	1	$\mu\text{A}$
Gate-body leakage current	$I_{\text{GSS}}$	$V_{\text{GS}} = \pm 12\text{V}, V_{\text{DS}}=0\text{V}$	-	-	$\pm 100$	nA
Gate threshold voltage	$V_{\text{GS}(\text{th})}$	$V_{\text{DS}}=V_{\text{GS}}, I_D=250\mu\text{A}$	0.5	-	1.1	V
Static drain-source on-resistance	$V_{\text{GS}(\text{th})}$	$V_{\text{GS}}=4.5\text{V}, I_D=30\text{A}$	-	2.8	4.0	$\text{m}\Omega$
		$V_{\text{GS}}=2.5\text{V}, I_D=20\text{A}$	-	4.0	6.0	$\text{m}\Omega$
Forward transconductance	$g_{\text{FS}}$	$V_{\text{DS}}=5\text{V}, I_D=5\text{A}$	-	-	50	S
Diode forward voltage	$V_{\text{SD}}$	$I_S=1\text{A}, V_{\text{GS}}=0\text{V}$	-	0.75	1	V
Diode continuous current	$I_S$	$T_c=25^\circ\text{C}$	-	-	100	A
<b>DYNAMIC PARAMETERS</b>						
Input capacitance	$C_{\text{ISS}}$	$V_{\text{GS}}=0\text{V}, V_{\text{DS}}=10\text{V}, f=1\text{MHz}$	-	3200	-	pF
Output capacitance	$C_{\text{OSS}}$		-	460	-	pF
Reverse transfer capacitance	$C_{\text{rss}}$		-	445	-	pF
Gate resistance	$R_g$		-	1.4	-	$\Omega$
<b>SWITCHING PARAMETERS</b>						
Total charge	$Q_g$	$V_{\text{GS}}=4.5\text{V}$ $V_{\text{DS}}=10\text{V}, I_D=30\text{A}$	-	48	-	nC
Gate source charge	$Q_{\text{gs}}$		-	3.6	-	nC
Gate drain charge	$Q_{\text{gd}}$		-	19	-	nC
Turn-on delay time	$t_{\text{D(on)}}$	$V_{\text{GS}}=4.5\text{V}, V_{\text{DD}}=10\text{V}$ $I_D=30\text{A}, R_{\text{GEN}}=1.8\Omega$	-	9.7	-	nS
Turn-on rise time	$t_r$		-	37	-	nS
Turn-off delay time	$t_{\text{D(off)}}$		-	63	-	nS
Turn-off fall time	$t_f$		-	52	-	nS
Body-diode reverse recovery time	$t_{\text{rr}}$	$I_F=30\text{A}, dI_F/dt=100\text{A}/\mu\text{s}$	-	23	-	nS
Body-diode reverse recovery charge	$Q_{\text{rr}}$	$I_F=30\text{A}, dI_F/dt=100\text{A}/\mu\text{s}$	-	10	-	nC

### ■ TYPICAL CHARACTERISTICS

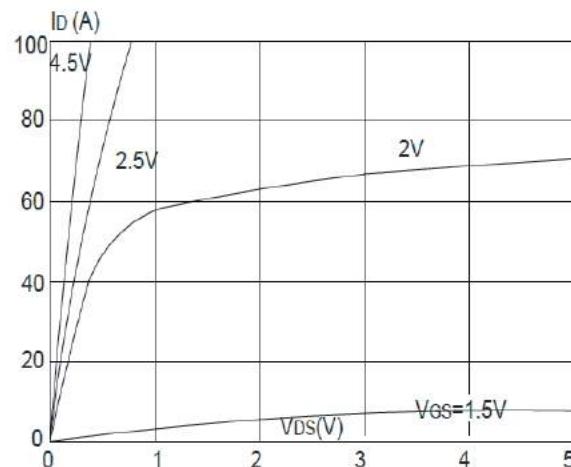


Figure 1: Output Characteristics

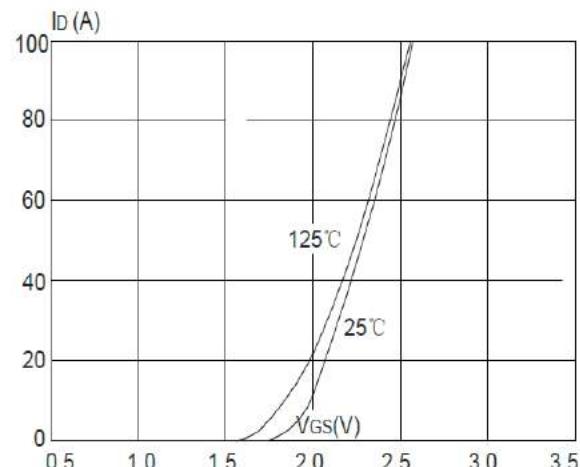


Figure 2: Typical Transfer Characteristics

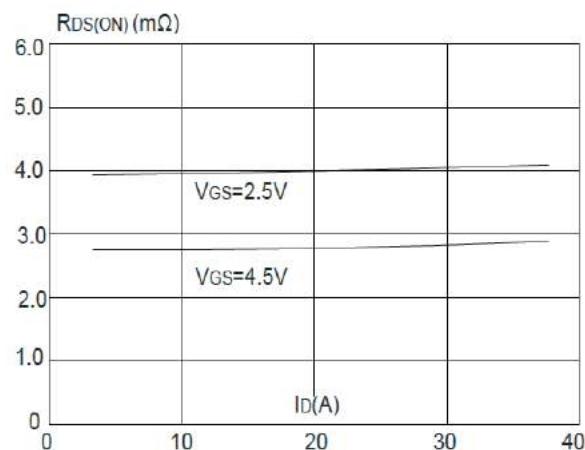


Figure 3: On-resistance vs. Drain Current

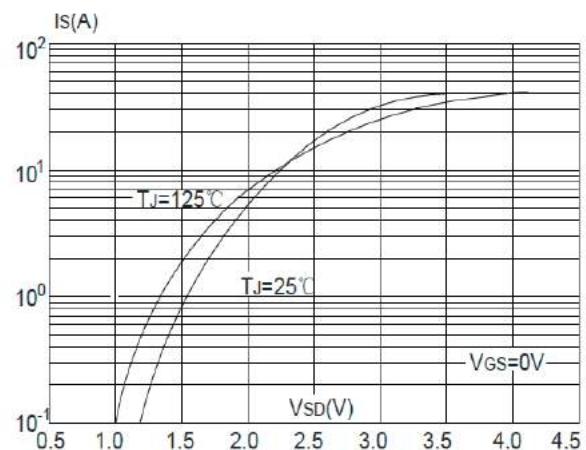


Figure 4: Body Diode Characteristics

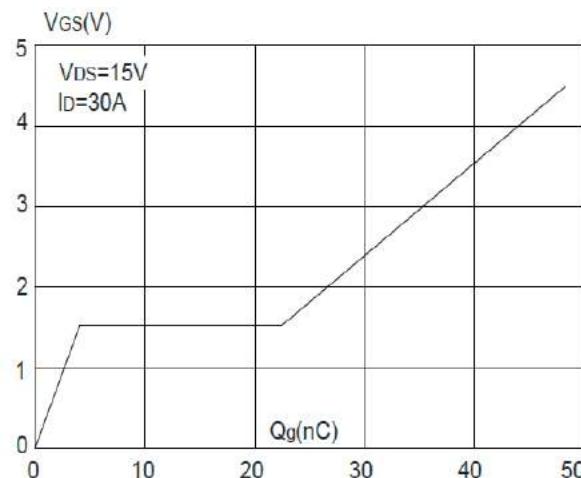


Figure 5: Gate Charge Characteristics

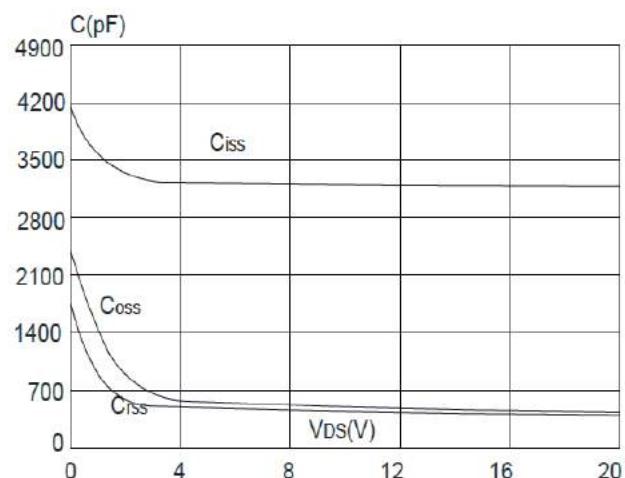


Figure 6: Capacitance Characteristics

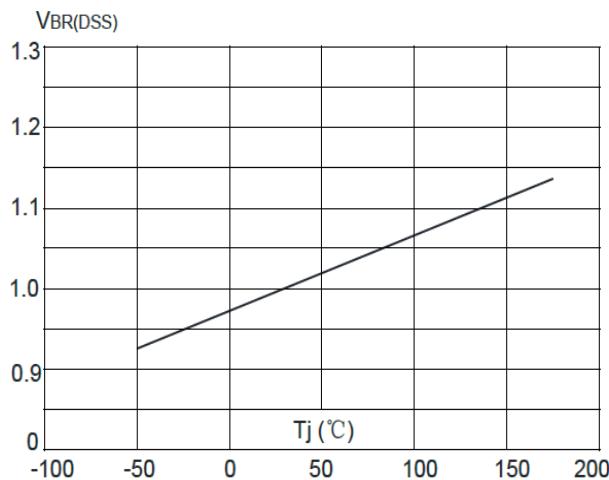
**■ TYPICAL CHARACTERISTICS(Cont.)**


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

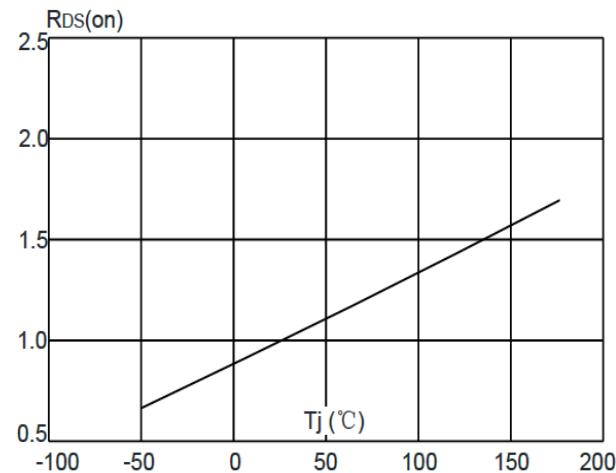


Figure 8: Normalized on Resistance vs. Junction Temperature

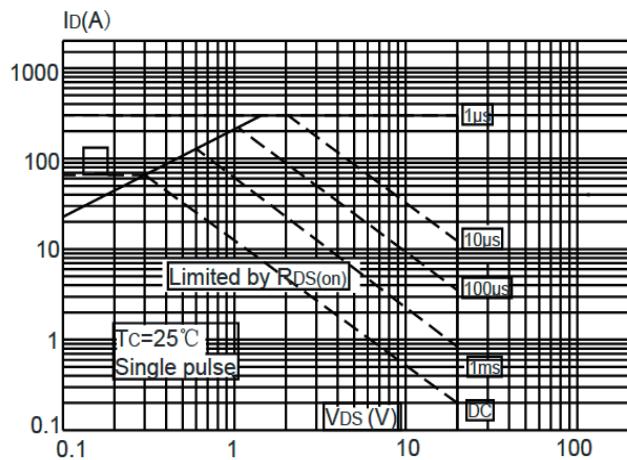


Figure 9: Maximum safe operating area

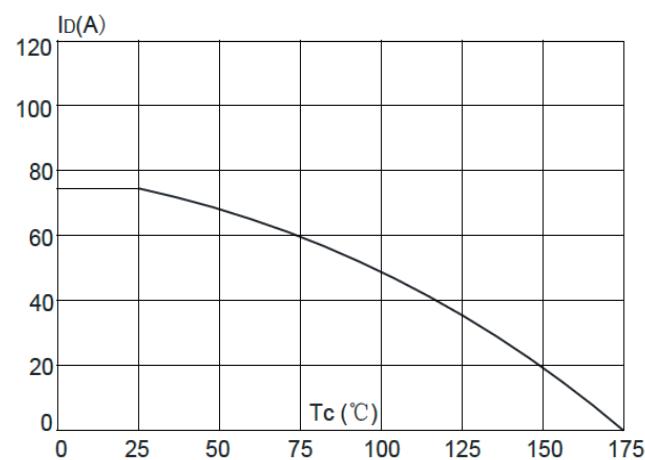


Figure 10: Maximum drain current vs. case Temperature

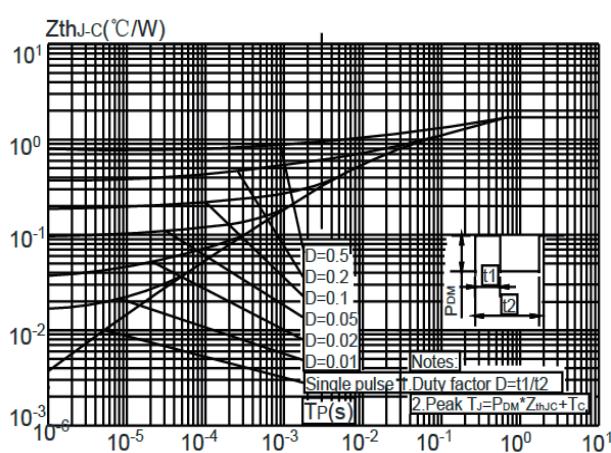
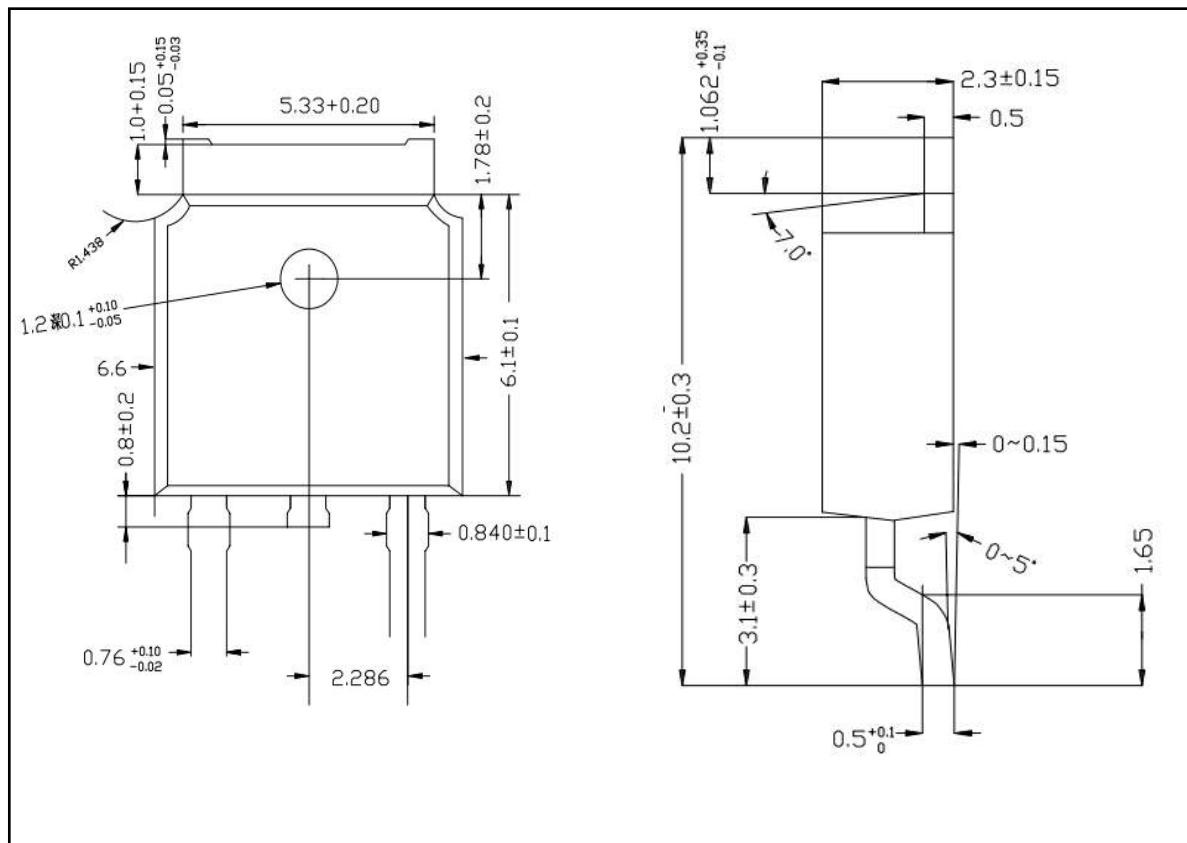


Figure 11: Maximum Effective Transient Thermal Impedance, Junction-to-Casense curve

■ TO-252 PACKAGE OUTLINE DIMENSIONS



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